MIC-3666

Dual 10 Gigabit Ethernet XMC



Features

- Intel® 82599 Dual Port 10 Gigabit Ethernet Controller
- PCIe x8 Gen.2 host interface
- Dual SFP+ connectors
- Compliant with VITA 42.0-2005, 42.3-2006 XMC specifications

Introduction

The MIC-3666 is a low power, dual-port 10 GbE XMC, with SFP+ pluggable modules for multi-mode and single-mode fiber media and is based on the Intel[®] 82599ES 10 Gigabit Ethernet controller. The XMC provides a high performance PCIe x8 interface at 5 Gb/s per lane at an outstanding low power dissipation of less than 10W. Support for Intel[®]'s offloading and platform enhancement features yields maximum network throughput while preserving valuable CPU cycles for application processing.

The MIC-3666 features an Intel® 82599 which provides Intel® Virtualization Technology for Connectivity (VT-c) including Virtual Machine Device Queues (VMDq) and PCI_SIG compliant Single Root I/O Virtualization (SR-IOV), helping to reduce I/O bottlenecks, boost throughput, and reduce latency. Where virtualization is required, VMDqs improve performance by offloading the data-sorting burden from the virtual machine manager (VMM) to the network controller. The MIC-3666's specialized features include Layer 2 & 3 security with IPSec & LinkSec; Intel® I/OAT Acceleration Technology v3.0; VLAN tagging, stripping and packet filtering; and TCP, iSCSI, and Fiber Channel over Ethernet (FCoE) offload.

Specifications

XMC Connectivity	Connector	P15 assembled,		
	Host interface	PCIe x8 gen.2 @ 5Gbps/lane		
Controller	Controller	Intel® 82599ES dual 10GbE MAC/PHY		
	Virtualization Technologies	VMDg, VMD, SR-IOV		
	IP	IPv4, IPv6		
	Queues	128RX, 128TX per port		
	Offloading	TCP, UDP, SCTP, FCoE		
	Security Acceleration	Linksec IEEE802.1ae (AES-128 Authorization./Encryption) IPSec (AES-128, 1024 SA's)		
I/O	SFP+	2 sites with support for presence detect, status and ID EEPROM		
	LEDs	Network Link, Activity		
Software	Linux	X86 Kernel 2.6.x		
	Windows	Server2008		
	Boot	PXE, iSCSI		
Power	Power Consumption	+3.3V	VPWR (+5V)	
	Does not include FOT Transceivers	0.25A max	1.5A max	
Environment		Operating	Non-Operating	
	Temperature	0 ~ 60° C (32 ~ 140° F)	-40 ~ 80° C (-40 ~ 176° F)	
	Humidity	95 % @ 40° C, non-condensing	95 %@ 60° C, non-condensing	
Physical Characteristics	Dimensions (W x D)	74 x 149 mm (2.9" x 5.78")		
	Weight	0.104 kg (0.23 lbs)		
Compliance	IEEE Std 1386.1-2001 PMC specification			
	VITA 42.0-2005, 42.3-2006 XMC specifications			

Recommended Configurations

XMC Extension Board	CPU Board
MIC-3312-A1E	MIC-3393B-M2E, MIC-3395, MIC-3396

Ordering Information

Part Number	Description
MIC-3666-AE	XMC with dual SFP+ 10GbE interface



MIC-3666-AE

RoHS